

RESIN COMPOSITION AND CROSSLINKED MICROPARTICLE DISPERSED CURABLE RESIN COMPOSITION

Publication number: JP2000178398 (A)

Publication date: 2000-06-27

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Classification:

- international: C08J3/24; C08F220/10; C08L33/06; C09D4/02; C09D5/00; C09D7/12; C08J3/24; C08F220/00; C08L33/00; C09D4/02; C09D5/00; C09D7/12; (IPC1-7): C08J3/24; C09D4/02; C09D5/00; C09D7/12; C08L33/06; C08F220/10

- European:

Application number: JP19990257406 19990910

Priority number(s): JP19990257406 19990910; JP19980285495 19981007

Abstract of JP 2000178398 (A)

PROBLEM TO BE SOLVED: To provide a curable resin composition capable of simultaneously satisfying the three performances of low viscosity, low shrinkage, and rapid curability. SOLUTION: This composition is prepared by dispersing (A) crosslinked microparticles obtained by polymerizing (a) a radical-polymerizable ethylenically unsaturated compound and (b) a compound having at least three (meth)acryloyl groups in the molecule and having a mean primary particle diameter in the range of 10-1,000 nm in (B) a compound having at least one (meth)acryloyl group on the molecule.

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